

**MAXIMUM RATINGS**

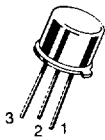
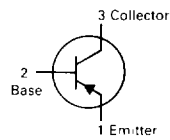
Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO}$	-80	Vdc
Collector-Base Voltage	$V_{CBO}$	-80	Vdc
Emitter-Base Voltage	$V_{EBO}$	-5.0	Vdc
Collector Current — Continuous	$I_C$	-1.0	Adc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	1.25 7.15	Watts $\text{mW}/^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	8.75 50	Watts $\text{mW}/^\circ\text{C}$
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-65 to +200	$^\circ\text{C}$

**THERMAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	140	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Case	$R_{\theta JC}$	20	$^\circ\text{C}/\text{W}$

**2N4404**  
**2N4405**

**CASE 79-04, STYLE 1**  
**TO-39 (TO-205AD)**

**GENERAL PURPOSE**  
**TRANSISTORS**

**PNP SILICON**

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
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**OFF CHARACTERISTICS**

Collector-Emitter Breakdown Voltage(1) ( $I_C = -10 \text{ mAdc}, I_B = 0$ )	$V_{(BR)CEO}$	-80	—	Vdc
Collector-Base Breakdown Voltage ( $I_C = -10 \mu\text{Adc}, I_E = 0$ )	$V_{(BR)CBO}$	-80	—	Vdc
Emitter-Base Breakdown Voltage ( $I_E = -10 \mu\text{Adc}, I_C = 0$ )	$V_{(BR)EBO}$	-5.0	—	Vdc
Collector Cutoff Current ( $V_{CB} = -60 \text{ Vdc}, I_E = 0$ )	$I_{CBO}$	—	-25	nAdc
Emitter Cutoff Current ( $V_{EB} = -3.0 \text{ Vdc}, I_C = 0$ )	$I_{EBO}$	—	-25	nAdc

**ON CHARACTERISTICS**

DC Current Gain ( $I_C = -0.1 \text{ mAdc}, V_{CE} = -5.0 \text{ Vdc}$ )	2N4404 2N4405	$h_{FE}$	30 75	—	—
( $I_C = -10 \text{ mAdc}, V_{CE} = -5.0 \text{ Vdc}$ )(1)	2N4404 2N4405		40 100	—	—
( $I_C = -150 \text{ mAdc}, V_{CE} = -5.0 \text{ Vdc}$ )(1)	2N4404 2N4405		40 100	120 300	—
( $I_C = -500 \text{ mAdc}, V_{CE} = -5.0 \text{ Vdc}$ )(1)	2N4404 2N4405		30 50	—	—
Collector-Emitter Saturation Voltage ( $I_C = -10 \text{ mAdc}, I_B = -1.0 \text{ mAdc}$ )(1) ( $I_C = -150 \text{ mAdc}, I_B = -15 \text{ mAdc}$ )(1) ( $I_C = -500 \text{ mAdc}, I_B = -50 \text{ mAdc}$ )(1)		$V_{CE(sat)}$	— — —	-0.15 -0.2 -0.5	Vdc
Base-Emitter Saturation Voltage ( $I_C = -10 \text{ mAdc}, I_B = -1.0 \text{ mAdc}$ )(1) ( $I_C = -500 \text{ mAdc}, I_B = -50 \text{ mAdc}$ )(1)		$V_{BE(sat)}$	— -0.85	-0.8 -1.2	Vdc
Base-Emitter On Voltage ( $I_C = -150 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc}$ )(1)		$V_{BE(on)}$	—	-0.9	Vdc

**SMALL-SIGNAL CHARACTERISTICS**

Current-Gain — Bandwidth Product ( $I_C = -50 \text{ mAdc}, V_{CE} = -20 \text{ Vdc}, f = 100 \text{ MHz}$ )	$f_T$	200	600	MHz
Collector-Base Capacitance ( $I_C = -10 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz}$ )	$C_{cb}$	—	10	pF
Emitter-Base Capacitance ( $V_{EB} = -0.5 \text{ Vdc}, I_C = 0, f = 1.0 \text{ MHz}$ )	$C_{eb}$	—	75	pF

## 2N4404, 2N4405

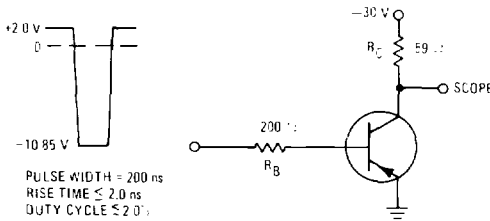
**ELECTRICAL CHARACTERISTICS** (continued) ( $T_A = 25^\circ\text{C}$  unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit	
<b>SWITCHING CHARACTERISTICS</b>					
Delay Time	$(V_{CC} = -30\text{ Vdc}, V_{BE(\text{off})} = +2.0\text{ Vdc}, I_C = -500\text{ mAdc}, I_{B1} = -50\text{ mAdc})$	$t_d$	—	15	ns
Rise Time		$t_r$	—	25	ns
Storage Time		$t_s$	—	175	ns
Fall Time		$t_f$	—	35	ns

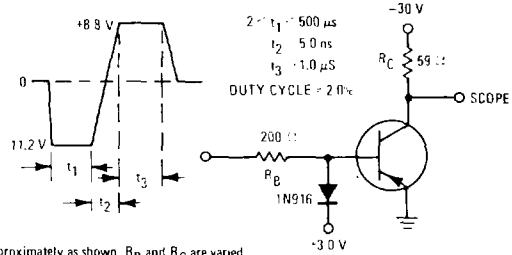
(1) Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

### SWITCHING TIME EQUIVALENT TEST CIRCUITS

**FIGURE 1 — TURN-ON**



**FIGURE 2 — TURN-OFF**

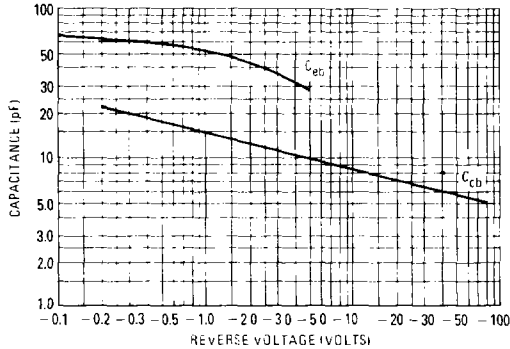


To obtain data for curves, voltage levels are approximately as shown.  $R_B$  and  $R_C$  are varied.

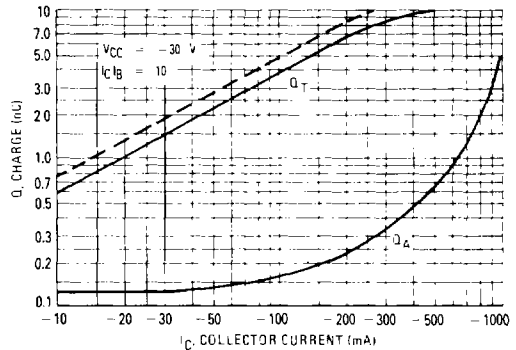
### TRANSIENT CHARACTERISTICS

$25^\circ\text{C}$        $100^\circ\text{C}$

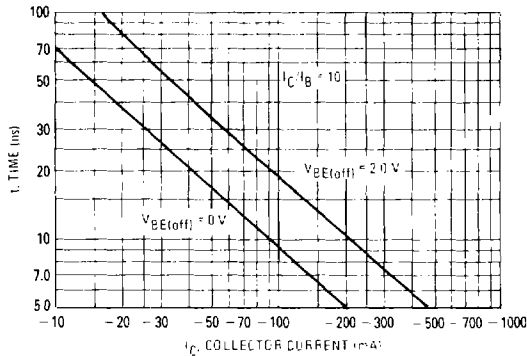
**FIGURE 3 — CAPACITANCES**



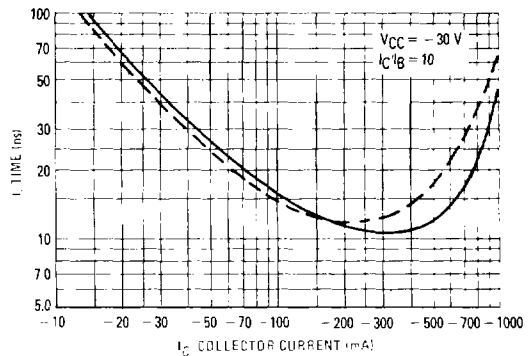
**FIGURE 4 — CHARGE DATA**



**FIGURE 5 — DELAY TIME**



**FIGURE 6 — RISE TIME**



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FIGURE 7 — STORAGE TIME

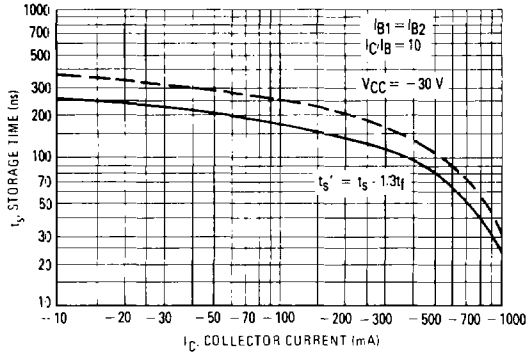
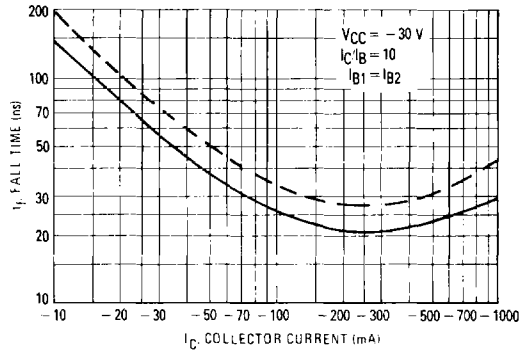


FIGURE 8 — FALL TIME



SMALL-SIGNAL CHARACTERISTICS  
NOISE FIGURE

$V_{CE} = 10 \text{ Vdc}$ ,  $T_A = 25^\circ\text{C}$

FIGURE 9 — FREQUENCY EFFECTS

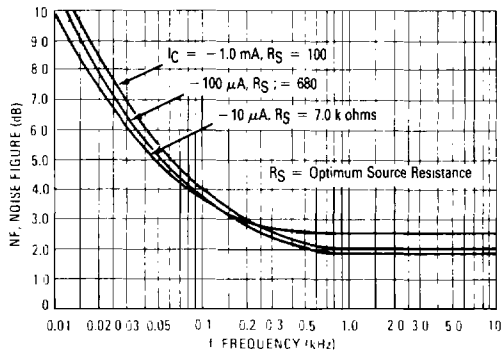
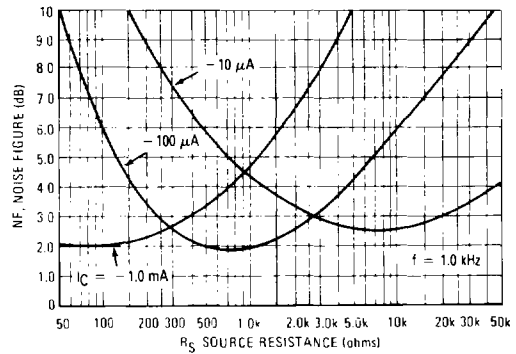


FIGURE 10 — SOURCE RESISTANCE EFFECTS



h PARAMETERS

$V_{CE} = 10 \text{ Vdc}$ ,  $f = 1.0 \text{ kHz}$ ,  $T_A = 25^\circ\text{C}$

This group of graphs illustrates the relationship of the "h" parameters for this series of transistors. To obtain these curves 4 units were selected and identified by number — the same units were used to develop curves on each graph.

FIGURE 11 — CURRENT GAIN

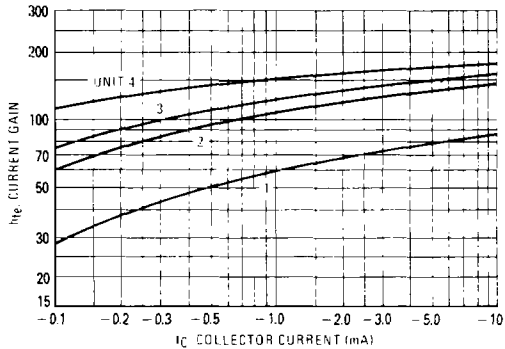
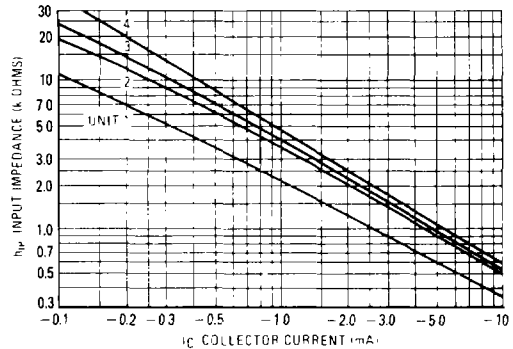


FIGURE 12 — INPUT IMPEDANCE



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FIGURE 13 — VOLTAGE FEEDBACK RATIO

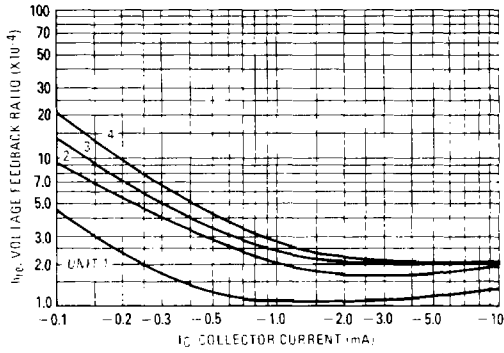
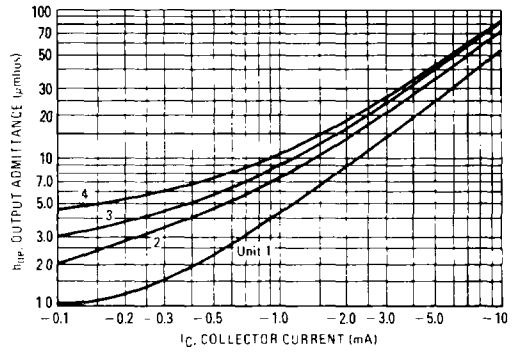


FIGURE 14 — OUTPUT ADMITTANCE



STATIC CHARACTERISTICS

FIGURE 15 — DC CURRENT GAIN

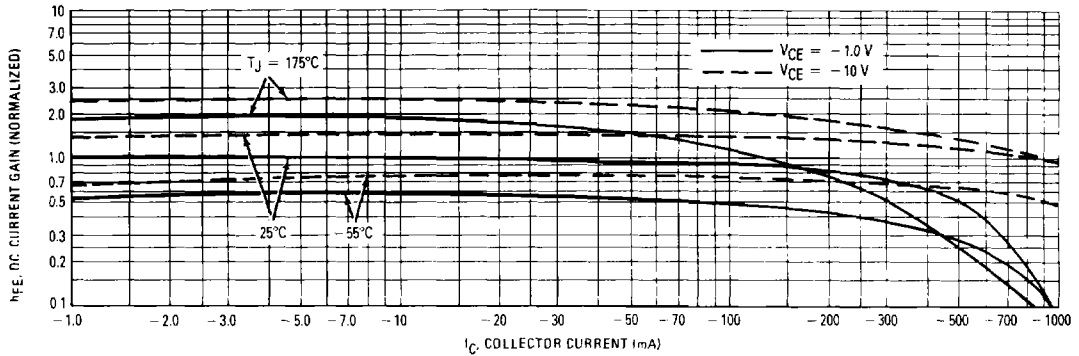
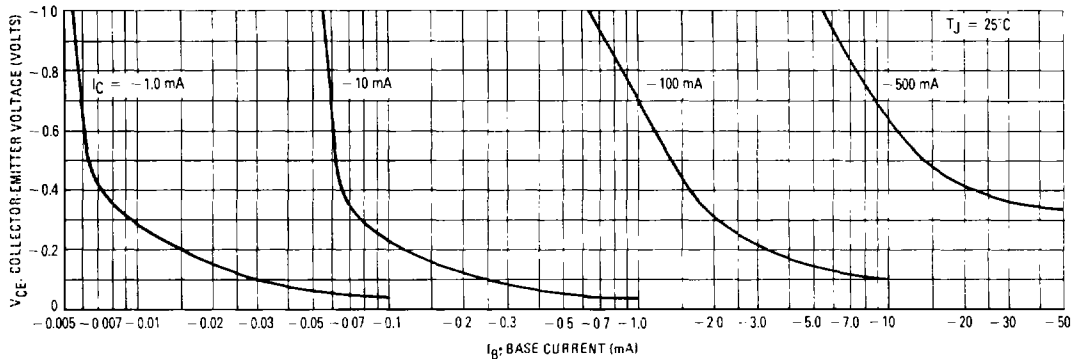


FIGURE 16 — COLLECTOR SATURATION REGION



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FIGURE 17 — "ON" VOLTAGES

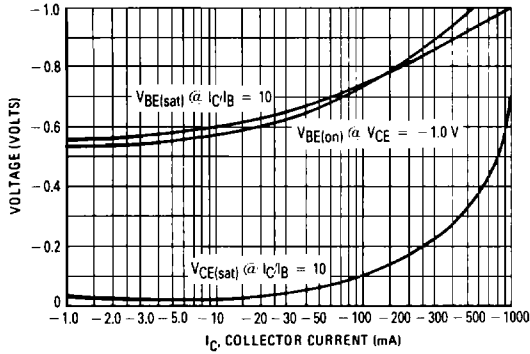
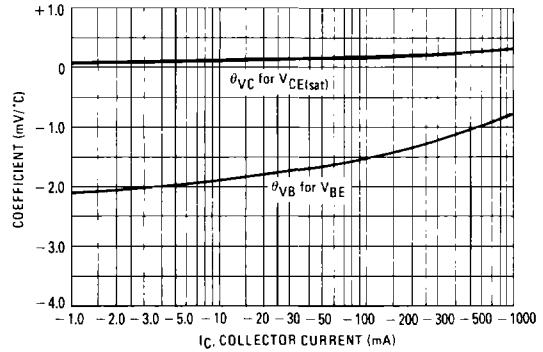


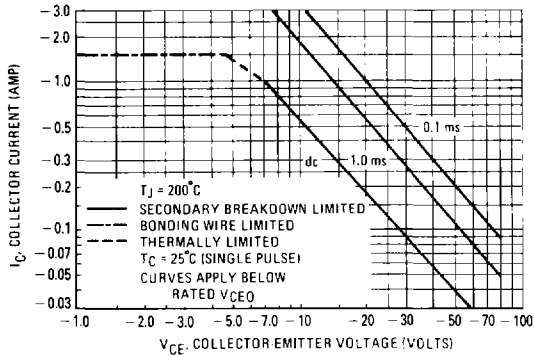
FIGURE 18 — TEMPERATURE COEFFICIENTS



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### RATINGS AND THERMAL DATA

FIGURE 19 — SAFE OPERATING AREA



The safe operating area curves indicate  $I_C$ - $V_{CE}$  limits of the transistor that must be observed for reliable operation. Collector load lines for specific circuits must fall below the limits indicated by the applicable curve.

The data of Figure 19 is based upon  $T_{J(pk)} = 200^\circ\text{C}$ ;  $T_C$  is variable depending upon conditions. Pulse curves are valid for duty cycles to 10% provided  $T_{J(pk)} \leq 200^\circ\text{C}$ .  $T_{J(pk)}$  may be calculated from the data in Figure 20. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by secondary breakdown.